

# MCD 1,5/ 8-G1F-3,81 - PCB header



1842979

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PCB headers, nominal cross section: 1.5 mm<sup>2</sup>, color: green, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Tin, contact connection type: Pin, number of potentials: 16, number of rows: 2, number of positions: 8, number of connections: 16, product range: MCD 1,5/..-G1F, pitch: 3.81 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.5 mm, number of solder pins per potential: 1, plug-in system: COMBICON MC 1,5, Pin connector pattern alignment: Standard, locking: Screw locking mechanism, mounting: Threaded flange, type of packaging: packed in cardboard, In combination with MCV plug components, both an MCVW and an MCVR plug must be used.

## Your advantages

- Well-known mounting principle allows worldwide use
- Screwable flange for superior mechanical stability
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies
- Conductor connection on several levels enables higher contact density

## Commercial data

Item number	1842979
Packing unit	50 pc
Minimum order quantity	50 pc
Sales key	AA02
Product key	AABSHC
Catalog page	Page 235 (C-1-2013)
GTIN	4017918112172
Weight per piece (including packing)	12.598 g
Weight per piece (excluding packing)	11.932 g
Customs tariff number	85366930
Country of origin	DE

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## Technical data

### Product properties

Type	Standard
Product line	COMBICON Connectors S
Product type	PCB headers
Product family	MCD 1,5/...-G1F
Number of positions	8
Pitch	3.81 mm
Number of connections	16
Number of rows	2
Mounting flange	Threaded flange
Number of potentials	16
Pin layout	Linear pinning
Solder pins per potential	1

### Electrical properties

Nominal current $I_N$	8 A
Nominal voltage $U_N$	160 V
Degree of pollution	3
Contact resistance	1.2 m $\Omega$
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

### Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

### Flange

Tightening torque	0.3 Nm
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### Material specifications

#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 $\mu\text{m}$ Sn)
Metal surface contact area (middle layer)	Nickel (1 - 3 $\mu\text{m}$ Ni)
Metal surface soldering area (top layer)	Tin (3 - 5 $\mu\text{m}$ Sn)

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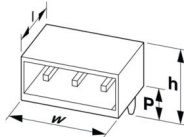
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Metal surface soldering area (middle layer)	Nickel (1 - 3 µm Ni)
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## Material data - housing

Color (Housing)	green (6021)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

## Dimensions

Dimensional drawing	
Pitch	3.81 mm
Width [w]	40.87 mm
Height [h]	26.2 mm
Length [l]	21.9 mm
Installed height	22.7 mm
Solder pin length [P]	3.5 mm
Pin dimensions	0.8 x 0.8 mm

## PCB design

Pin spacing	12.70 mm
Hole diameter	1.2 mm

## Mechanical tests

### Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

### Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

### Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

### Polarization and coding

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Specification	IEC 60512-13-5:2006-02
Result	Test passed

## Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

## Insertion and withdrawal forces

Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	5 N

## Electrical tests

### Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	16

### Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

### Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.5 mm
Rated insulation voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

## Environmental and real-life conditions

### Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min

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Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Sweep speed	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h

## Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R <sub>1</sub>	1.2 mΩ
Contact resistance R <sub>2</sub>	1.3 mΩ
Contact resistance R <sub>2</sub> 2nd level	2.2 mΩ
Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 MΩ

## Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm <sup>3</sup> SO <sub>2</sub> on 300 dm <sup>3</sup> /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

## Shocks

Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	30g
Shock duration	18 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)

## Ambient conditions

Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C

## Packaging specifications

Type of packaging	packed in cardboard
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## Classifications

### ECLASS

ECLASS-11.0	27460201
ECLASS-12.0	27460201
ECLASS-13.0	27460201

### ETIM

ETIM 9.0	EC002637
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### UNSPSC

UNSPSC 21.0	39121400
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## Environmental product compliance

REACH SVHC	Lead 7439-92-1
China RoHS	Environmentally Friendly Use Period = 50 years
	For information on hazardous substances, refer to the manufacturer's declaration available under "Downloads"

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